



## **General Description**

The MAX9713/MAX9714 mono/stereo Class D audio power amplifiers provide Class AB amplifier performance with Class D efficiency, conserving board space and eliminating the need for a bulky heatsink. Using a Class D architecture, these devices deliver up to 6W while offering greater than 85% efficiency. Proprietary and protected modulation and switching schemes render the traditional Class D output filter unnecessary.

The MAX9713/MAX9714 offer two modulation schemes: a fixed-frequency mode (FFM), and a spread-spectrum mode (SSM) that reduces EMI-radiated emissions due to the modulation frequency. The device utilizes a fully differential architecture, a full bridged output, and comprehensive click-and-pop suppression.

The MAX9713/MAX9714 feature high 76dB PSRR, low 0.07% THD+N, and SNR in excess of 95dB. Short-circuit and thermal-overload protection prevent the devices from being damaged during a fault condition. The MAX9713 is available in a 32-pin TQFN (5mm x 5mm x 0.8mm) package. The MAX9714 is available in a 32-pin TQFN (7mm x 7mm x 0.8mm) package. Both devices are specified over the extended -40°C to +85°C temperature range.

#### **Applications**

High-End Notebook LCD Monitors Audio LCD TVs Hands-Free Car Desktop PCs Phone Adaptors LCD Projectors

# Features

- **♦ Filterless Class D Amplifier**
- ♦ Unique Spread-Spectrum Mode Offers 5dB **Emissions Improvement Over Conventional** Methods
- ♦ Up to 85% Efficient
- ♦ 6W Output Power into 8Ω
- ♦ Low 0.07% THD+N
- ♦ High PSRR (76dB at 1kHz)
- ♦ 10V to 25V Single-Supply Operation
- **♦ Differential Inputs Minimize Common-Mode Noise**
- ♦ Pin-Selectable Gain Reduces Component Count
- ♦ Industry-Leading Integrated Click-and-Pop Suppression
- **♦ Low Quiescent Current (18mA)**
- ♦ Low-Power Shutdown Mode (0.2µA)
- ♦ Short-Circuit and Thermal-Overload Protection
- ♦ Available in Thermally Efficient, Space-Saving **Packages**

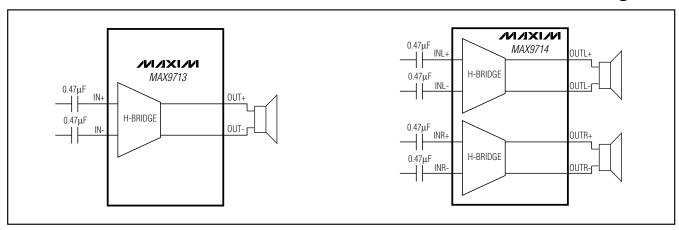
32-Pin TQFN (5mm x 5mm x 0.8mm)-MAX9713 32-Pin TQFN (7mm x 7mm x 0.8mm)-MAX9714

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE	AMP
MAX9713ETJ+	-40°C to +85°C	32 TQFN-EP*	Mono
MAX9714ETJ+	-40°C to +85°C	32 TQFN-EP*	Stereo

<sup>\*</sup>EP = Exposed paddle.

## **Block Diagrams**



Pin Configurations appear at end of data sheet.

MIXIM

Maxim Integrated Products 1

<sup>+</sup>Denotes lead-free package.

#### **ABSOLUTE MAXIMUM RATINGS**

ID.)
30V
0.3V to (V <sub>DD</sub> + 0.3V)
$(V_{DD} - 0.3V)$ to (CHOLD + 0.3V)
(V <sub>DD</sub> - 0.3V) to +40V
0.3V to +12V
Continuous
o, PGND, AGND)1.6A
other pins)±20mA

Continuous Power Dissipation (T <sub>A</sub> = +70°C) Single-Layer Board:	
MAX9713 32-Pin TQFN (derate 21.3mW/°C	
above +70°C)	1702.1mW
MAX9714 32-Pin TQFN (derate 27mW/°C	
above +70°C)	2162.2mW
Multilayer Board:	
MAX9713 32-Pin TQFN (derate 34.5mW/°C	
above +70°C)	2758.6mW
MAX9714 32-Pin TQFN (derate 37mW/°C	
above +70°C)	2963.0mW
Junction Temperature	+150°C
Operating Temperature Range	
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = 15V, GND = PGND = 0V, \overline{SHDN} \ge V_{IH}, A_V = 16dB, C_{SS} = C_{IN} = 0.47\mu F, C_{REG} = 0.01\mu F, C1 = 100nF, C2 = 1\mu F, FS1 = FS2 = GND (f_S = 330kHz), R_L connected between OUTL+ and OUTL- and OUTR+ and OUTR-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)$ 

PARAMETER	SYMBOL	COI	MIN	TYP	MAX	UNITS		
GENERAL	•	•		•			•	
Supply Voltage Range	$V_{DD}$	Inferred from PSRR to	Inferred from PSRR test				V	
0: 10 1			MAX9713		10	17.5		
Quiescent Current	IDD	$R_L = \infty$ MAX9714			18	23	mA	
Shutdown Current	ISHDN				0.2	1.5	μΑ	
Turn-On Time		C <sub>SS</sub> = 470nF			100			
rum-On Time	ton	C <sub>SS</sub> = 180nF			50		ms	
Amplifier Output Resistance in Shutdown		SHDN = GND	150	330		kΩ		
		$A_V = 13dB$	vy = 13dB			80		
		$A_V = 16dB$		30	48	65	1.0	
Input Impedance	R <sub>IN</sub>	$A_V = 19.1 dB$	23	39	55	kΩ		
		$A_V = 22.1 dB$		20	31	42	7	
		G1 = L, G2 = L	21.9	22.1	22.3			
Voltage Cain	Δ.,	G1 = L, G2 = H	18.9	19.1	19.3	] _ [		
Voltage Gain	Av	G1 = H, G2 = L		12.8	13	13.2	dB	
		G1 = H, G2 = H	15.9	16	16.3			
Gain Matching		Between channels (M		0.5		%		
Output Offset Voltage	Vos			±6	±30	mV		
Common-Mode Rejection Ratio	CMRR	f <sub>IN</sub> = 1kHz, input refe		60		dB		
D 0 1 D : 1: D ::		$V_{DD} = 10V \text{ to } 25V$	54	76				
Power-Supply Rejection Ratio (Note 3)	PSRR	200m\/p p ripple	f <sub>RIPPLE</sub> = 1kHz		76		dB	
(NOTO O)		200mV <sub>P-P</sub> ripple	f <sub>RIPPLE</sub> = 20kHz		60		]	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DD}=15V, GND=PGND=0V, \overline{SHDN} \geq V_{IH}, A_{V}=16dB, C_{SS}=C_{IN}=0.47\mu F, C_{REG}=0.01\mu F, C1=100nF, C2=1\mu F, FS1=FS2=GND (f_{S}=330kHz), R_{L} connected between OUTL+ and OUTL- and OUTR+ and OUTR-, T_{A}=T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_{A}=+25°C.) (Notes 1, 2)$ 

PARAMETER	SYMBOL	C	ONDITIONS		MIN	TYP	MAX	UNITS		
Output Dower	Dour-	THD+N = 10%,	$R_L = 16\Omega$	8			W			
Output Power	Pout	f = 1kHz	$R_L = 8\Omega$		6			VV		
Total Harmonic Distortion Plus Noise	THD+N	f <sub>IN</sub> = 1kHz, either F P <sub>OUT</sub> = 4W	FFM or SSM, R <sub>L</sub> =	= 8Ω,		0.07		%		
			BW = 22Hz to	FFM		94				
Signal-to-Noise Ratio	CNID	$R_L = 8\Omega$ , $P_{OUT} =$	22kHz	SSM		88		1		
	SNR	4W, f = 1kHz	Aaisabta.d	FFM		97		dB		
			A-weighted	SSM		91		<u>]                                    </u>		
		FS1 = L, FS2 = L	300	335	370					
On a illustrating Fire and a second	f	FS1 = L, FS2 = H				460		kHz		
Oscillator Frequency	fosc	FS1 = H, FS2 = L				236		KHZ		
		FS1 = H, FS2 = H		335						
Efficiency		Pout = 5W, fin = 1	IkHz, $R_L = 16\Omega$			85		0/		
Efficiency	η	POUT = 4W, f = 1k	Hz, $R_L = 8\Omega$			75		- %		
DIGITAL INPUTS (SHDN, FS_,	G_)									
located Thomas Inc.		VIH	VIH					V		
Input Thresholds		VIL					0.8	]		
Input Leakage Current			±1				±1	μΑ		

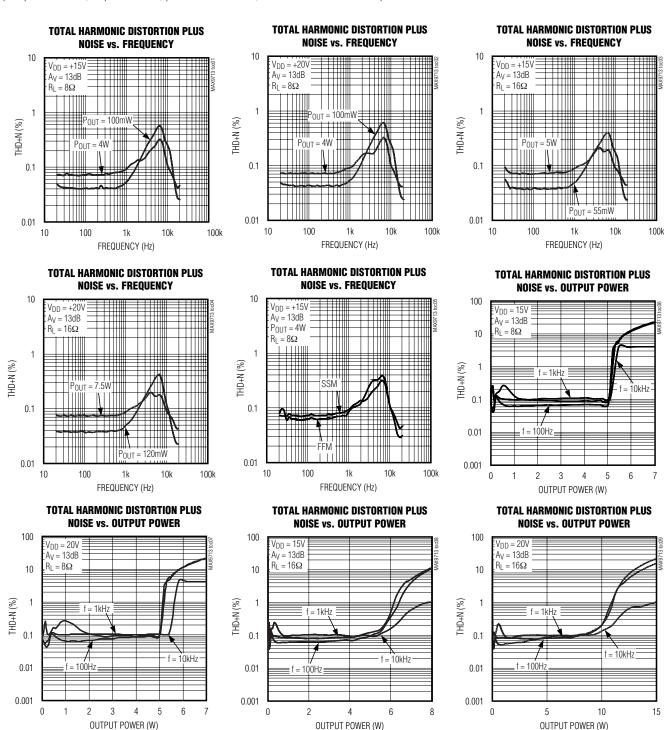
Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.

Note 2: Testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For  $R_L = 8\Omega$ ,  $L = 68\mu H$ . For  $R_L = 16\Omega$ ,  $L = 136\mu H$ .

Note 3: PSRR is specified with the amplifier inputs connected to GND through CIN.

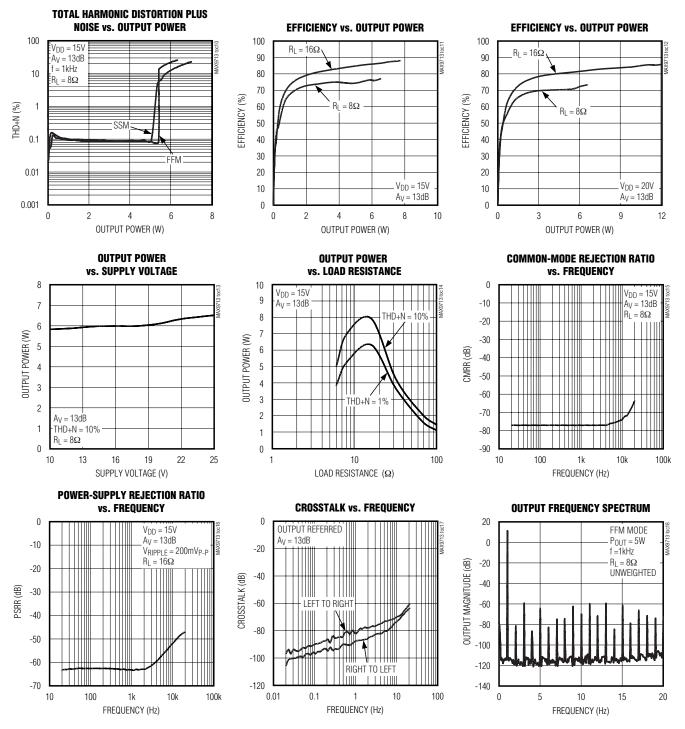
## Typical Operating Characteristics

(136 $\mu$ H with 16 $\Omega$ , 68 $\mu$ H with 8 $\Omega$ , part in SSM mode, unless otherwise noted.)



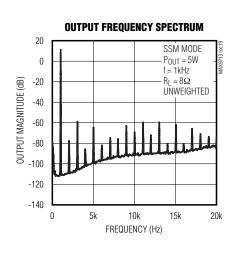
## **Typical Operating Characteristics (continued)**

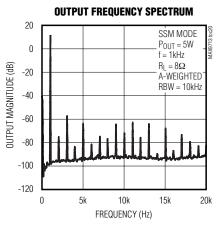
(136 $\mu$ H with 16 $\Omega$ , 68 $\mu$ H with 8 $\Omega$ , part in SSM mode, unless otherwise noted.)

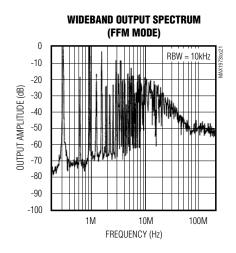


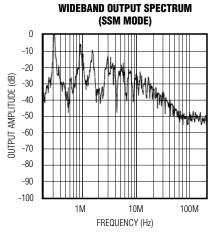
## Typical Operating Characteristics (continued)

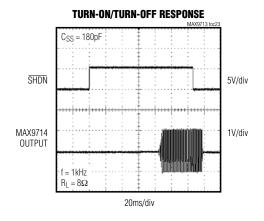
(136 $\mu$ H with 16 $\Omega$ , 68 $\mu$ H with 8 $\Omega$ , part in SSM mode, unless otherwise noted.)

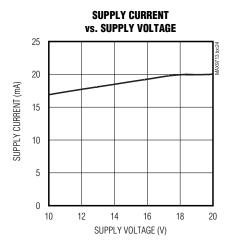


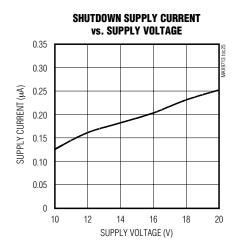












# **Pin Description**

PIN						
MAX9713	MAX9714	NAME	FUNCTION			
1, 2, 23, 24	1, 2, 23, 24	PGND	Power Ground			
3, 4, 21, 22	3, 4, 21, 22	$V_{DD}$	Power-Supply Input			
5	5	C1N	Charge-Pump Flying Capacitor Negative Terminal			
6	6	C1P	Charge-Pump Flying Capacitor Positive Terminal			
7	7	CHOLD	Charge-Pump Hold Capacitor. Connect a 1µF capacitor from CHOLD to V <sub>DD</sub> .			
8, 17, 20, 25, 26, 31, 32	8	N.C.	No Connection. Not internally connected.			
9	14	REG	6V Internal Regulator Output. Bypass with a 0.01µF capacitor to PGND.			
10	13	AGND	Analog Ground			
11	_	IN-	Negative Input			
12	_	IN+	Positive Input			
13	12	SS	Soft-Start. Connect a 0.47µF capacitor from SS to GND to enable soft-start feature.			
14	11	SHDN	Active-Low Shutdown. Connect $\overline{\text{SHDN}}$ to GND to disable the device. Connect to $V_{DD}$ for normal operation.			
15	17	G1	Gain-Select Input 1			
16	18	G2	Gain-Select Input 2			
18	19	FS1	Frequency-Select Input 1			
19	20	FS2	Frequency-Select Input 2			
27, 28	_	OUT-	Negative Audio Output			
29, 30	_	OUT+	Positive Audio Output			
_	9	INL-	Left-Channel Negative Input			
_	10	INL+	Left-Channel Positive Input			
_	15	INR-	Right-Channel Negative Input			
_	16	INR+	Right-Channel Positive Input			
_	25, 26	OUTR-	Right-Channel Negative Audio Output			
_	27, 28	OUTR+	Right-Channel Positive Audio Output			
_	29, 30	OUTL-	Left-Channel Negative Audio Output			
_	31, 32	OUTL+	Left-Channel Positive Audio Output			
_	_	EP	Exposed Paddle. Connect to GND.			

## **Detailed Description**

The MAX9713/MAX9714 filterless, Class D audio power amplifiers feature several improvements to switch-mode amplifier technology. The MAX9713 is a mono amplifier, the MAX9714 is a stereo amplifier. These devices offer Class AB performance with Class D efficiency, while occupying minimal board space. A unique filterless modulation scheme and spread-spectrum switching mode create a compact, flexible, lownoise, efficient audio power amplifier. The differential input architecture reduces common-mode noise pickup, and can be used without input-coupling capacitors. The devices can also be configured as a single-ended input amplifier.

Comparators monitor the device inputs and compare the complementary input voltages to the triangle waveform. The comparators trip when the input magnitude of the triangle exceeds their corresponding input voltage.

#### **Operating Modes**

#### Fixed-Frequency Modulation (FFM) Mode

The MAX9713/MAX9714 feature three FFM modes with different switching frequencies (Table 1). In FFM mode, the frequency spectrum of the Class D output consists of the fundamental switching frequency and its associated harmonics (see the Wideband Output Spectrum (FFM Mode) graph in the *Typical Operating Characteristics*). The MAX9713/ MAX9714 allow the switching frequency to be changed by ±35%, should the frequency of one or more of the harmonics fall in a sensitive band. This can be done at any time and not affect audio reproduction.

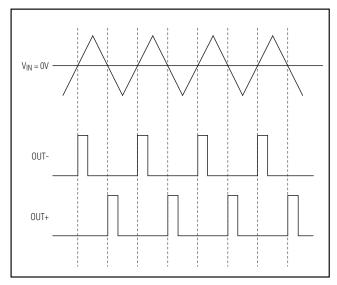


Figure 1. MAX9714 Outputs with No Input Signal Applied

#### **Table 1. Operating Modes**

FS1	FS2	SWITCHING MODE (kHz)
L	L	335
L	Н	460
Н	L	236
Н	Н	335 ±7%

#### Spread-Spectrum Modulation (SSM) Mode

The MAX9713/MAX9714 feature a unique spread-spectrum mode that flattens the wideband spectral components, improving EMI emissions that may be radiated by the speaker and cables. This mode is enabled by setting FS1 = FS2 = H. In SSM mode, the switching frequency varies randomly by  $\pm 1.7\%$ kHz around the center frequency (335kHz). The modulation scheme remains the same, but the period of the triangle waveform changes from cycle to cycle. Instead of a large amount of spectral energy present at multiples of the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few megahertz, the wideband spectrum looks like white noise for EMI purposes (Figure 2).

#### **Efficiency**

Efficiency of a Class D amplifier is attributed to the region of operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I<sup>2</sup>R loss of the MOSFET on-resistance, and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78%, however that efficiency is only exhibited at peak output powers. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the MAX9714 still exhibits >80% efficiencies under the same conditions (Figure 3).

#### Shutdown

The MAX9713/MAX9714 have a shutdown mode that reduces power consumption and extends battery life. Driving SHDN low places the device in low-power (0.2µA) shutdown mode. Connect SHDN to a logic high for normal operation.

#### Click-and-Pop Suppression

The MAX9713/MAX9714 feature comprehensive clickand-pop suppression that eliminates audible transients on startup and shutdown. While in shutdown, the Hbridge is pulled to GND through 300k $\Omega$ . During startup,

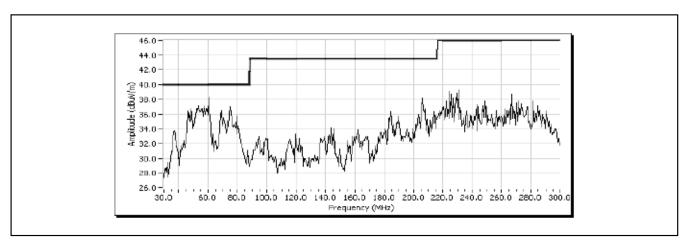


Figure 2. SSM Radiated Emissions

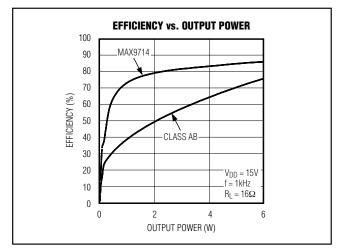


Figure 3. MAX9714 Efficiency vs. Class AB Efficiency

or power-up, the input amplifiers are muted and an internal loop sets the modulator bias voltages to the correct levels, preventing clicks and pops when the H-bridge is subsequently enabled. Following startup, a soft-start function gradually un-mutes the input amplifiers. The value of the soft-start capacitor has an impact on the click/pop levels. For optimum performance, CSS should be at least 0.18µF.

#### **Mute Function**

The MAX9713/MAX9714 feature a clickless/popless mute mode. When the device is muted, the outputs stop switching, muting the speaker. Mute only affects the output state, and does not shut down the device. To mute the MAX9713/MAX9714, drive SS to GND by

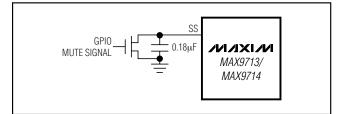


Figure 4. MAX9713/MAX9714 Mute Circuit

using a MOSFET pulldown (Figure 4). Driving SS to GND during the power-up/down or shutdown/turn-on cycle optimizes click-and-pop suppression.

## \_Applications Information

#### **Filterless Operation**

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's PWM output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency. The traditional PWM scheme uses large differential output swings (2 × V<sub>DD</sub> peak-to-peak) and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The MAX9713/MAX9714 do not require an output filter. The devices rely on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, more efficient solution.

Because the frequency of the MAX9713/MAX9714 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency

Table 2. Gain Settings

GAIN (dB)	DIFF INPUT (VRMS)	<b>R</b> <sub>L</sub> (Ω)	POUT at 10% THD+N (W)
13.0	1.27	16	8
16.1	0.89	16	8
19.1	0.63	16	8
22.1	0.45	16	8
13.0	0.78	8	6
16.1	0.54	8	6
19.1	0.39	8	6
22.1	0.27	8	6

is very small. Although this movement is small, a speaker not designed to handle the additional power can be damaged. For optimum results, use a speaker with a series inductance > 30 $\mu$ H. Typical 8 $\Omega$  speakers exhibit series inductances in the range of 30 $\mu$ H to 100 $\mu$ H. Optimum efficiency is achieved with speaker inductances > 60 $\mu$ H.

#### **Gain Selection**

Table 2 shows the suggested gain settings to attain a maximum output power from a given peak input voltage and given load.

#### Internal Regulator Output (VREG)

The MAX9713/MAX9714 feature an internal, 6V regulator output (VREG). The MAX9713/MAX9714 REG output pin simplifies system design and reduces system cost by providing a logic voltage high for the MAX9713/MAX9714 logic pins (G\_, FS\_). VREG is not available as a logic voltage high in shutdown mode. Do not apply VREG as an input voltage high to the MAX9713/MAX9714  $\overline{\rm SHDN}$  pin. Do not apply VREG as a 6V potential to surrounding system components. Bypass REG with a 6.3V, 0.01µF capacitor to GND.

#### **Output Offset**

Unlike a Class AB amplifier, the output offset voltage of Class D amplifiers does not noticeably increase quiescent current draw when a load is applied. This is due to the power conversion of the Class D amplifier. For example, an 8mV DC offset across an  $8\Omega$  load results in 1mA extra current consumption in a Class AB device. In the Class D case, an 8mV offset into  $8\Omega$  equates to an additional power drain of  $8\mu W$ . Due to the high efficiency of the Class D amplifier, this represents an additional quiescent current draw of:  $8\mu W/(V_{DD}/100\times\eta)$ , which is on the order of a few microamps.

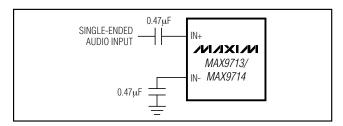


Figure 5. Single-Ended Input

#### **Input Amplifier**

#### Differential Input

The MAX9713/MAX9714 feature a differential input structure, making them compatible with many CODECs, and offering improved noise immunity over a single-ended input amplifier. In devices such as PCs, noisy digital signals can be picked up by the amplifier's input traces. The signals appear at the amplifiers' inputs as commonmode noise. A differential input amplifier amplifies the difference of the two inputs, any signal common to both inputs is canceled.

#### Single-Ended Input

The MAX9713/MAX9714 can be configured as singleended input amplifiers by capacitively coupling either input to GND and driving the other input (Figure 5).

#### Component Selection

#### Input Filter

An input capacitor,  $C_{IN}$ , in conjunction with the input impedance of the MAX9713/MAX9714, forms a high-pass filter that removes the DC bias from an incoming signal. The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

Choose  $C_{\text{IN}}$  so  $f_{\text{-}3dB}$  is well below the lowest frequency of interest. Setting  $f_{\text{-}3dB}$  too high affects the low-frequency response of the amplifier. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

#### Charge-Pump Capacitor Selection

Use capacitors with an ESR less than  $100m\Omega$  for optimum performance. Low-ESR ceramic capacitors minimize the output resistance of the charge pump. For best performance over the extended temperature range, select capacitors with an X7R dielectric.

#### Flying Capacitor (C1)

The value of the flying capacitor (C1) affects the load regulation and output resistance of the charge pump. A C1 value that is too small degrades the device's ability to provide sufficient current drive. Increasing the value of C1 improves load regulation and reduces the charge-pump output resistance to an extent. Above 1µF, the onresistance of the switches and the ESR of C1 and C2 dominate.

#### Output Capacitor (C2)

The output capacitor value and ESR directly affect the ripple at CHOLD. Increasing C2 reduces output ripple. Likewise, decreasing the ESR of C2 reduces both ripple and output resistance. Lower capacitance values can be used in systems with low maximum output power levels.

#### **Output Filter**

The MAX9713/MAX9714 do not require an output filter. The device passes FCC emissions standards with 36cm of unshielded speaker cables. However, output filtering can be used if a design is failing radiated emissions due to board layout or cable length, or the circuit is near EMI-sensitive devices. Use a ferrite bead filter when radiated frequencies above 10MHz are of concern. Use an LC filter when radiated frequencies below 10MHz are of concern, or when long leads connect the

amplifier to the speaker. Refer to the MAX9714 Evaluation Kit schematic for details of this filter.

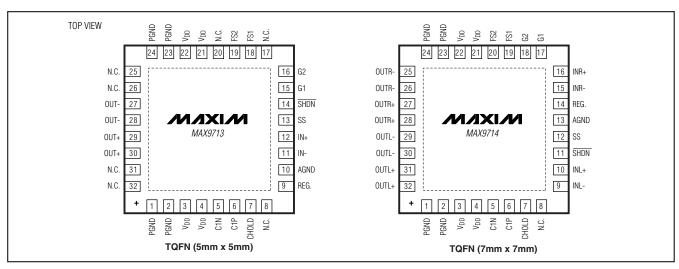
#### **Sharing Input Sources**

In certain systems, a single audio source can be shared by multiple devices (speaker and headphone amplifiers). When sharing inputs, it is common to mute the unused device, rather than completely shutting it down, preventing the unused device inputs from distorting the input signal. Mute the MAX9713/MAX9714 by driving SS low through an open-drain output or MOSFET (see the *System Diagram*). Driving SS low turns off the Class D output stage, but does not affect the input bias levels of the MAX9713/MAX9714. Be aware that during normal operation, the voltage at SS can be up to 7V, depending on the MAX9713/MAX9714 supply.

#### Supply Bypassing/Layout

Proper power-supply bypassing ensures low distortion operation. For optimum performance, bypass  $V_{DD}$  to PGND with a 0.1µF capacitor as close to each  $V_{DD}$  pin as possible. A low-impedance, high-current power-supply connection to  $V_{DD}$  is assumed. Additional bulk capacitance should be added as required depending on the application and power-supply characteristics. AGND and PGND should be star connected to system ground. Refer to the MAX9714 Evaluation Kit for layout guidance.

## Pin Configurations

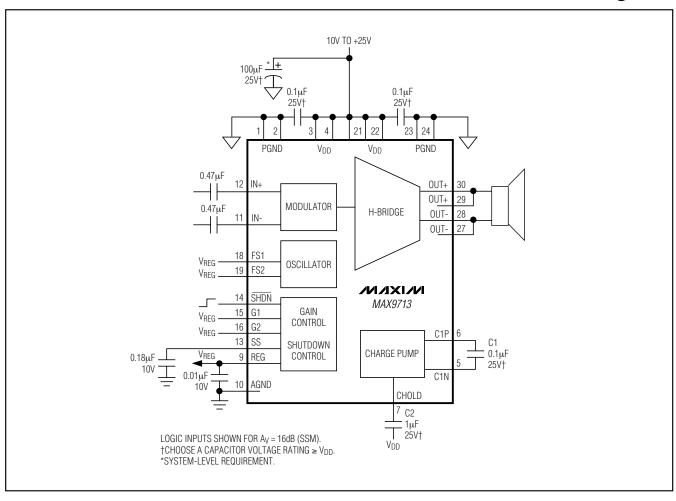


### **Chip Information**

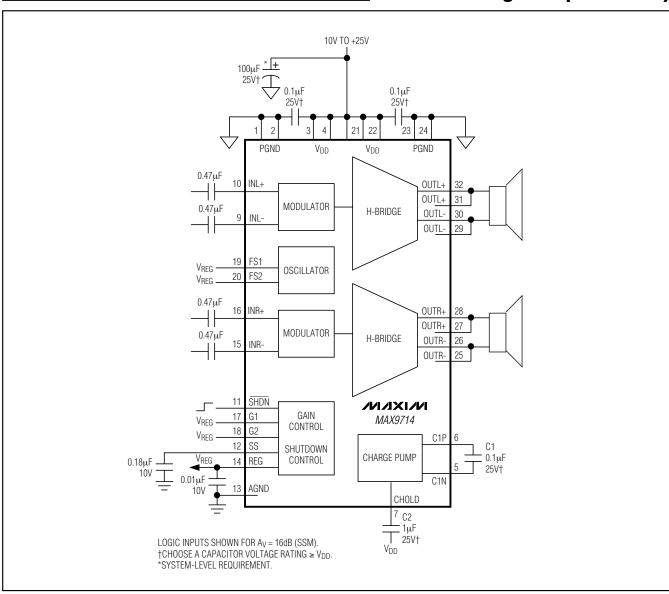
MAX9713 TRANSISTOR COUNT: 3093 MAX9714 TRANSISTOR COUNT: 4630

PROCESS: BiCMOS

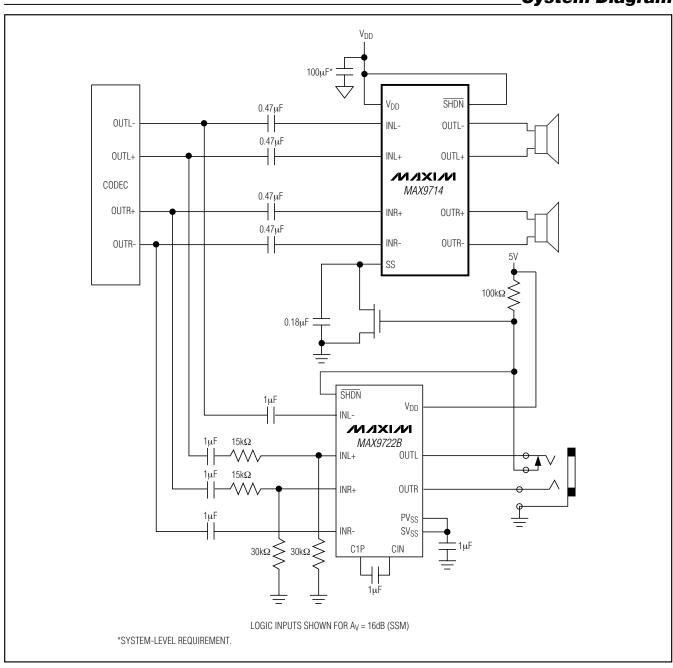
## **Functional Diagrams**



# Functional Diagrams (continued)

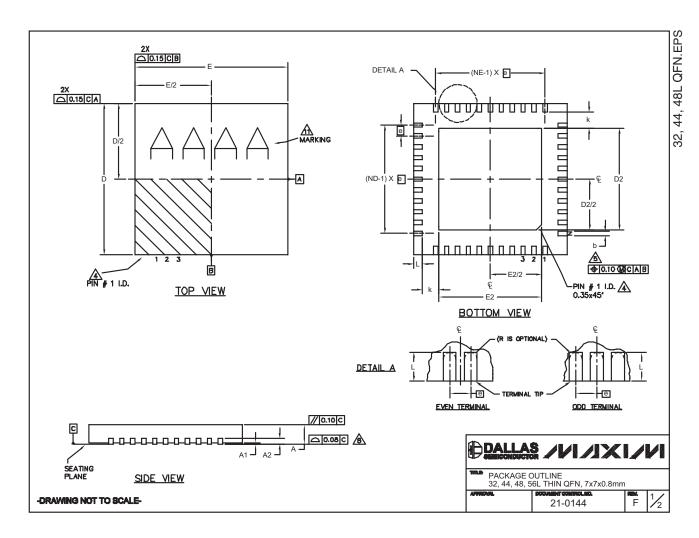


## System Diagram



## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)

	COMMON DIMENSIONS															
								TOM P								
PKG	;	32L 7x	7	4	4L 7x	7	٠	4BL 7x	7	4	BL 7x7	7	5	6L 7x	7	
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	
A1	0	0.02	0.05	٥	0.02	0.05	a	0.02	0.05	0	0.02	0.05	a	_	0.05	
A2	0	.20 RE	F.	(	0.20 REF.			0.20 REF. 0.20 REF.			F.	0.20 REF.				
ь	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25	
D	6.90	7.00	7.10	6 <b>.9</b> D	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	
E	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	
a	0	.65 BS	C.	(	.50 B	SC.		0.50 BS	SC.	ı	.50 BS	c.	0	.40 BS	ic.	
k	0.25	_	-	0.25	_	-	0.25	-	-	0.25	-	-	0.25	-	_	
L	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.45	0.55	0.65	0.30	0.40	0.50	
N		32			44			48			44			56		
ND		8			11			12		10			14			
NE		8			11			12			12			14		

	EXPOSED PAD VARIATIONS							
PKG.	DEPOPULATED		D2			E2		JEDEC MO220
CODES	LEADS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	REV. C
T3277-2	-	4.55	4.70	4.85	4.55	4.70	4.85	-
T3277-3	-	4.55	4.70	4.85	4.55	4.70	4.85	_
T4477-2	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1
T4477-3	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1
T4877-1**	13,24,37,48	4.20	4.30	4.40	4.20	4.30	4.40	-
T4877-3	-	4.95	5.10	5.25	4.95	5.10	5.25	_
T4877-4	-	5.40	5.50	5.60	5.40	5,50	5.60	-
T4877-5	-	2.40	2.50	2.60	2.40	2.50	2.60	_
T4877-6	-	5.40	5.50	5.60	5.40	5.50	5.60	_
T4877-7	-	4.95	5.10	5.25	4.95	5.10	5.25	_
T4877M-1	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877M-6	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877MN-8	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T5677-1	-	5.40	5.50	5.60	5.40	5,50	5.60	_
T5677-2	<b> -</b>	5.40	5.50	5.60	5.40	5,50	5.60	<u> </u>

\*\* NOTE: T4877-1 IS A CUSTON 48L PKG. WITH 4 LEADS DEPOPULATED. TOTAL NUMBER OF LEADS ARE 44.

#### NOTES:

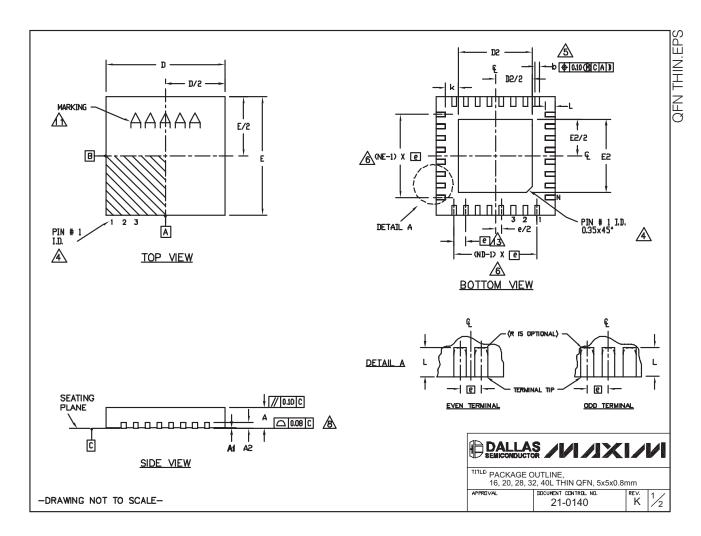
- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION & APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- 6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- 7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- & COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO220 EXCEPT THE EXPOSED PAD DIMENSIONS OF T4877-1/-3/-4/-5/-6 & T5677-1.
- 10. WARPAGE SHALL NOT EXCEED 0.10 mm.
- MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY
- 12. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY

-DRAWING NOT TO SCALE-



## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

	COMMON DIMENSIONS														
PKG.	10	5L 5	×5	2	0L :	5×5	2	:8L	5x5	3	2L	5×5	40L 5x5		5x5
SYMBOL	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05
A2	0.6	20 RE	F.	F. 0.20 REF.		0.2	20 RE	F.	0.2	20 RE	F.	0.20 REF.		F.	
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
Ε	4.90	5.00	5,10	4.90	5.00	5.10	4.90	5.00	5.10	4,90	5,00	5.10	4.90	5.00	5.10
e	0.	80 B	SC.	0.	65 B	SC.	0.	0.50 BSC. 0.50 BSC.		SC.	0.40 BSC.				
k	0.25		-	0.25			0.25	_	_	0.25	-	_	0.25	-	-
L	0.30	0.40	0.50	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N		16			20			28		32			40		
ND		4		5			7			8		10			
NE		4	4 5			7			8			10			
JEDEC	VHHB WHHO		WHHC		\ \	VHHD-	-1	W	/HHD-	2	_				

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
  - DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
  - DRAWING CONFORMS TO JEDEC MO220, EXCEPT EXPOSED PAD DIMENSION FOR T2855-3, T2855-6, T4055-1 AND T4055-2.
- √ON WARPAGE SHALL NOT EXCEED 0.10 mm.
- MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.
- NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- ⚠ LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION 'e', ±0.05.

-DRAWING NOT TO SCALE-

EXPOSED PAD VARIATIONS						
PKG.	D2			E2		
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
T1655-2	3.00	3.10	3.20	3.00	3.10	3.20
T1655-3	3.00	3.10	3.20	3.00	3.10	3.20
T1655N-1	3.00	3.10	3.20	3.00	3.10	3.20
T2055-3	3.00	3.10	3.20	3.00	3.10	3.20
T2055-4	3.00	3.10	3.20	3.00	3.10	3.20
T2055-5	3.15	3.25	3.35	3.15	3.25	3.35
T2055M-5	3.15	3.25	3.35	3.15	3.25	3.35
T2855-3	3.15	3.25	3.35	3.15	3.25	3.35
T2855-4	2.60	2.70	2.80	2.60	2.70	2.80
T2855-5	2.60	2.70	2.80	2.60	2.70	2.80
T2855-6	3.15	3.25	3.35	3.15	3.25	3.35
T2855-7	2.60	2.70	2.80	2.60	2.70	2.80
T2055-8	3.15	3.25	3.35	3.15	3,25	3.35
T2855N-1	3.15	3.25	3.35	3.15	3.25	3.35
T3255-3	3.00	3.10	3.20	3.00	3.10	3.20
T3255-4	3.00	3.10	3.20	3.00	3.10	3.20
T3255M-4	3.00	3.10	3.20	3.00	3.10	3.20
T3255-5	3.00	3.10	3.20	3.00	3.10	3.20
T3255N-1	3.00	3.10	3.20	3,00	3.10	3.20
T4055-1	3.40	3.50	3.60	3.40	3.50	3.60
T4055-2	3.40	3,50	3.60	3,40	3.50	3.60



<sup>TITLE</sup> PACKAGE OUTLINE, 16, 20, 28, 32, 40L THIN QFN, 5x5x0.8mm

21-0140

DOCUMENT CONTROL NO.

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## **Revision History**

Pages changed at Rev 6: 1, 3, 18

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